

PolarHV[™] HiPerFET Power MOSFET

IXFK 64N60P IXFX 64N60P

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode



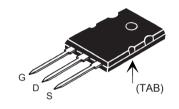
| P | I _{D25} | = | 64 | Α |
|------|-------------------------|---|-----|----|
| | R _{DS(on)} | ≤ | 96 | mΩ |
| | t _{rr} | ≤ | 200 | ns |
| OD D | | | | |

600

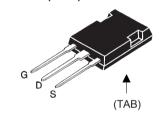
| Symbol | Test Conditions | Maximum Ratings | | |
|---|---|-----------------------------|----------------|--|
| V _{DSS} | T _J = 25° C to 150° C | 600 | V | |
| V _{DGR} | $T_J = 25^{\circ} C$ to $150^{\circ} C$; $R_{GS} = 1 M\Omega$ | 600 | V | |
| V _{GSS} | Continuous | ±30 | V | |
| $\mathbf{V}_{\mathtt{GSM}}$ | Transient | ±40 | V | |
| I _{D25} | T _C = 25° C | 64 | Α | |
| I _{DM} | $T_{\rm C}$ = 25° C, pulse width limited by $T_{\rm JM}$ | 150 | Α | |
| I _{AR} | T _C =25°C | 64 | А | |
| E _{AR} | T _C = 25° C | 80 | mJ | |
| E _{AS} | T _C = 25° C | 3.5 | J | |
| dv/dt | $I_{S} \leq I_{DM}$, di/dt ≤ 100 A/ μ s, $V_{DD} \leq V_{DSS}$, $T_{J} \leq 150^{\circ}$ C, $R_{G} = 2$ Ω | 20 | V/ns | |
| $\overline{P_{D}}$ | T _c = 25° C | 1040 | W | |
| T _J T _{JM} T _{stg} | | -55 +150 150 -55 +150 | °C °C °C | |
| T _L T _{SOLD} | 1.6 mm (0.062 in.) from case for 10 s Plastic body for 10 s | 300 260 | °C | |
| F _c | Mounting force (PLUS247) | 20120/4.525 | N/lb | |
| M _d | Mounting torque (TO-264) | 1.13/10 | Nm/lb.in. | |
| Weight | TO-264 PLUS247 | 10 6 | g g | |

| Symbol (T _J = 25° C, | Test Conditions unless otherwise specified) | Ch Min. | istic Va Max | |
|--|--|-------------------------|---------------------|----------|
| BV _{DSS} | $V_{GS} = 0 \text{ V}, I_{D} = 3 \text{ mA}$ | 600 | | V |
| V _{GS(th)} | $V_{DS} = V_{GS}$, $I_{D} = 8 \text{ mA}$ | 3.0 | 5.0 | V |
| I _{GSS} | $V_{GS} = \pm 30 V_{DC}, V_{DS} = 0$ | | ±200 | nA |
| I _{DSS} | $V_{DS} = V_{DSS}$ $V_{GS} = 0 V$ | T _J = 125° C | 25 1000 | μA μA |
| R _{DS(on)} | $V_{GS} = 10 \text{ V}, I_{D} = 0.5 I_{D25}, \text{ No}$ | te 1 | 96 | mΩ |

TO-264 (IXFK)



PLUS247 (IXFX)



G = Gate D = Drain S = Source Tab = Drain

Features

- ¹ International standard packages
- ¹ Fast recovery diode
- ¹ Unclamped Inductive Switching (UIS) rated
- ¹ Low package inductance
 - easy to drive and to protect

Advantages

- ¹ Easy to mount
- Space savings
- High power density



| Symbo | ol | Test Conditions | (T _J = 25° C, | | | | cified) |
|------------------------------|----|---|--------------------------------|----|------|------|---------|
| g_{fs} | | $V_{DS} = 20 \text{ V}; I_{D} = 0.5 I_{D25}, \text{ Not}$ | e 1 | 40 | 63 | | S |
| C _{iss} |) | | | | 12 | | nF |
| Coss | } | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1$ | MHz | | 1150 | | pF |
| \mathbf{C}_{rss} | J | | | | 80 | | pF |
| t _{d(on)} |) | | | | 28 | | ns |
| t _r | | $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS},$ | $I_{D} = 0.5 I_{D25}$ | | 23 | | ns |
| $\mathbf{t}_{d(off)}$ | 7 | $R_G = 1 \Omega$ (External) | | | 79 | | ns |
| $\mathbf{t}_{_{\mathbf{f}}}$ | | | | | 24 | | ns |
| $\mathbf{Q}_{g(on)}$ |) | | | | 200 | | nC |
| \mathbf{Q}_{gs} | } | $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS}, I$ | $_{\rm D}$ = 0.5 $I_{\rm D25}$ | | 70 | | nC |
| \mathbf{Q}_{gd} | J | | | | 68 | | nC |
| R _{thJC} | | | | | | 0.12 | ° C/W |
| R_{thCS} | | | | | 0.15 | | ° C/W |

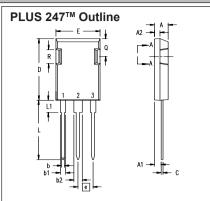
Source-Drain Diode

Characteristic Values (T₁ = 25° C, unless otherwise specified)

| Symb | ol | Test Conditions | Min. | Тур. | Max. | |
|-------------------|----|--------------------------------------|------|------|------|----|
| I _s | | V _{GS} = 0 V | | | 64 | Α |
| I _{sm} | | Repetitive | | | 150 | Α |
| V _{SD} | | $I_F = I_S$, $V_{GS} = 0$ V, Note 1 | | | 1.5 | V |
| t _{rr} |) | $I_F = 25A, -di/dt = 100 A/\mu s$ | | | 200 | ns |
| \mathbf{Q}_{RM} | } | V _R = 100V | | 0.6 | | μC |
| I _{RM} | | | | 6.0 | | Α |

Notes:

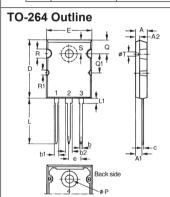
1. Pulse test, t \leq 300 μ s, duty cycle d \leq 2 %



Terminals: 1 - Gate

- 2 Drain (Collector) 3 Source (Emitter) 4 Drain (Collector)

| Dim. | Millimeter | | Inc | hes |
|----------------|------------|-------------------|------|-------|
| | Min. | Max. | Min. | Max. |
| Α | 4.83 | 5.21 | .190 | .205 |
| A, | 2.29 | 2.54 | .090 | .100 |
| A ₂ | 1.91 | 2.16 | .075 | .085 |
| b | 1.14 | 1.40 | .045 | .055 |
| b, | 1.91 | 2.13 | .075 | .084 |
| b ₂ | 2.92 | 3.12 | .115 | .123 |
| С | 0.61 | 0.80 | .024 | .031 |
| D | 20.80 | 21.34 | .819 | .840 |
| E | 15.75 | 16.13 | .620 | .635 |
| е | 5.45 | 5.45 BSC .215 BSC | | BSC |
| L | 19.81 | 20.32 | .780 | .800 |
| L1 | 3.81 | 4.32 | .150 | .170 |
| Q | 5.59 | 6.20 | .220 | 0.244 |
| R | 4.32 | 4.83 | .170 | .190 |



| Dim. | Milli | Millimeter Inc | | ches | |
|--------|----------|----------------|----------|-------|--|
| DIIII. | Min. | Max. | Min. | Max. | |
| Α | 4.82 | 5.13 | .190 | .202 | |
| A1 | 2.54 | 2.89 | .100 | .114 | |
| A2 | 2.00 | 2.10 | .079 | .083 | |
| b | 1.12 | 1.42 | .044 | .056 | |
| b1 | 2.39 | 2.69 | .094 | .106 | |
| b2 | 2.90 | 3.09 | .114 | .122 | |
| С | 0.53 | 0.83 | .021 | .033 | |
| D | 25.91 | 26.16 | 1.020 | 1.030 | |
| Е | 19.81 | 19.96 | .780 | .786 | |
| е | 5.46 BSC | | .215 BSC | | |
| J | 0.00 | 0.25 | .000 | .010 | |
| K | 0.00 | 0.25 | .000 | .010 | |
| L | 20.32 | 20.83 | .800 | .820 | |
| L1 | 2.29 | 2.59 | .090 | .102 | |
| Р | 3.17 | 3.66 | .125 | .144 | |
| Q | 6.07 | 6.27 | .239 | .247 | |
| Q1 | 8.38 | 8.69 | .330 | .342 | |
| R | 3.81 | 4.32 | .150 | .170 | |
| R1 | 1.78 | 2.29 | .070 | .090 | |
| S | 6.04 | 6.30 | .238 | .248 | |
| Т | 1.57 | 1.83 | .062 | .072 | |



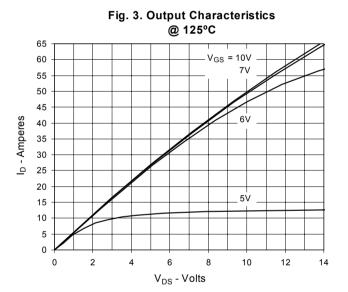
@ 25°C V_{GS} = 10V 8V 6V 5V

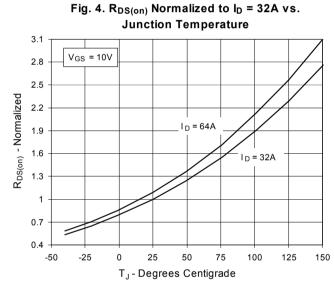
V_{DS} - Volts

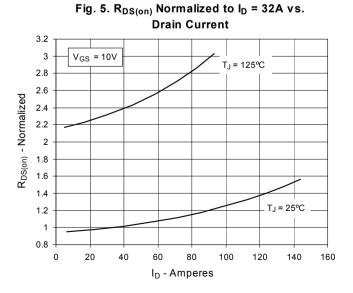
Fig. 1. Output Characteristics

@ 25°C V_{GS} = 10V ID - Amperes 5V V_{DS} - Volts

Fig. 2. Extended Output Characteristics







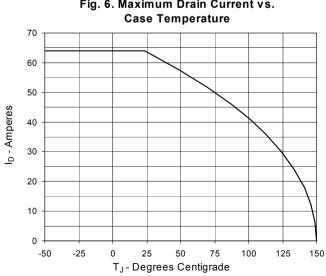


Fig. 6. Maximum Drain Current vs.

10

0 3.5

6.5

Fig. 7. Input Admittance

100 90 80 70 60 50 T_J = 125℃ 25℃ 40 - 40°C 30 20

Fig. 8. Transconductance

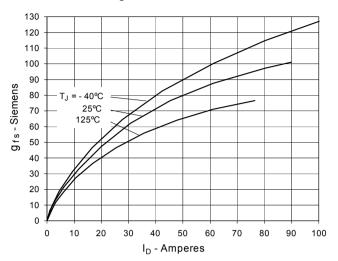


Fig. 9. Forward Voltage Drop of **Intrinsic Diode**

V_{GS} - Volts

4.5

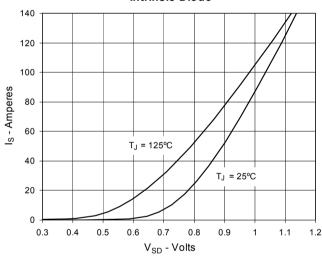


Fig. 10. Gate Charge

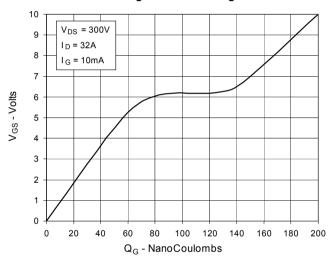


Fig. 11. Capacitance

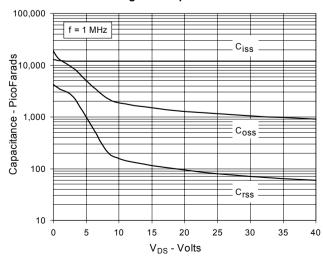
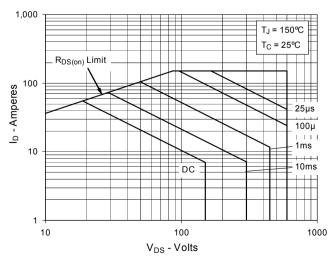


Fig. 12. Forward-Bias Safe Operating Area



IXYS reserves the right to change limits, test conditions, and dimensions.



1.000 0.100 0.001 0.001 0.001 0.001 0.001 0.001 0.001 0.001 0.001 0.001 0.001 0.001 0.001 0.001 0.001 0.001 0.001 0.001

Fig. 13. Maximum Transient Thermal Resistance

